

FEB. 19. 2003 9:58AM LERNERDAVID

NO. 013 P. 2

Election #7  
2/12/03

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Dated: July 10, 2002 Signature:   
(Marcus J. Millet)

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FEB 19 2003

Docket No.: TESSERA 3.0-159 DIV  
T.C. 2800 (PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
John W. Smith

Application No.: 09/942,363

Group Art Unit: 2825

Filed: August 29, 2001

Examiner: P. Greene

For: MICROELECTRONIC ASSEMBLIES WITH  
COMPOSITE CONDUCTIVE ELEMENTS

Commissioner for Patents  
Washington, DC 20231

RESPONSE

Dear Sir:

In response to the Official Action mailed June 28, 2002, Applicant hereby elects, with traverse, the claims of Group I, namely, claims 1-19, for examination in the present application.